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## Approved For Release 2004/05/05 : CIA-RDP78B95171A000600010012-0

NPIC/TSG/RED/SDB-050-70 28 October 1970

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	MEMORANDUM FOR: Chief, Research and Engineering Division, TSG  SUBJECT: Termination of Contract Chip System Implementation Study
25X1	1. In June 1969 a twelve-month study contract was awarded to  The study was to provide the NPIC with a detailed implementation plan for production and use of a formatted film chip system.
	2. The effort was established as a two-phase program wherein the Contractor was to perform a thorough investigation into equipment, methods and procedures, manpower, training, facilities, etc. From this investigation a report was prepared detailing all areas pertaining to the production and utilization of film chips in the Center. Options were presented from which the Center was to select those best suited for implementation. The Contractor was to then proceed into Phase II of the program and prepare, as a final report, a full and detailed implementation plan based upon the selected options. After a thorough Center evaluation of the preliminary (Phase I) report submitted in July 1970, it was determined that sufficient information was contained in that report to allow in-house preparation of an implementation plan if such action was required. Accordingly, the decision was made on 25 September 1970 to terminate Phase II of the program.
25X1	3. This investigation by was an extremely thorough effort resulting in a detailed report, which indirectly satisfied the objectives of the contract, and an approximate savings of to the Government. The contract, although not continued to completion, furnished the Center with sufficient technical parameters for implementation of such a plan, provided a sound technological base from which decisions can be made with supporting evidence, and defined equipment requirements.
	4. It is doubtful as to whether the Center will embark upon a chip system in the forseeable future as the operational units feel the utilization of chips versus roll material allows the possibility of oversight

Declass Review by NIMA/DOD

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	of information and that the implementation and operating costs outweigh the manhours saved.
	Project Monitor
25X1	CONCURRENCE:  Chief, Systems Development Branch RED/TSG/NPIC
25X1	Distribution: Original - Addressee 1 - Contract File 1 - SDB/RED/TSG/NPIC NPIC/TSG/RED/